

2K X 8 Electrically Erasable PROM

FEATURES

- Fast Read Access Times — 250ns, 300ns, 350ns, 450ns
- 5 Volt-only Operation — Including Write
- Industrial Temperature Range Available (XLE2816A)
- Fast Nonvolatile Write Cycle
 Internally Latched Data and Address
 10ms Nonvolatile Write Cycle
- Automatic Erase Before Write
- Automatic Write Timeout
- On-chip Inadvertent Write Protection
- Unlimited Read Cycle Endurance
- 10,000 Rewrites per Byte
- 10 Year Secure Data Retention
- TTL Compatible Inputs and Outputs
- JEDEC Approved Byte Wide Memory Pinout

OVERVIEW

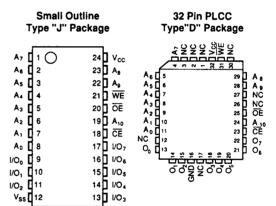
The XL2816A is a full-featured, 2K x 8 bit E²PROM (Electrically Erasable Programmable Read Only Memory). Operationally, it is compatible with industry standard 16K bit E²PROM devices, and it offers improved speed and power efficiency. Read access times are as low as 250ns; standby current, less than 40mA. The device is fully functional with a single 5V power supply, and the XL2816A is manufactured with EXEL's 2.5µ NMOS E²PROM process.

The sophisticated architecture of this device provides complete and automatic control of the nonvolatile write cycle eliminating the need for external timers, latches, high voltage generators and inadvertent write protection circuitry. It fits into a standard SRAM socket and responds to typical SRAM write commands.

PIN CONFIGURATION

| T | 24 Pin PDI ype "P" Paci | - | т | 24 Pin CERI ype "C" Pac | |
|--------------------|----------------------------|--------------------|-------------------|----------------------------|----------------------|
| A7 [| 1 | 24 V _{CC} | A7 [| 1 | 24] V _{CC} |
| A6 [| 2 | 23 A ₈ | A ₆ [| 2 | 23 A ₈ |
| As [| 3 | 22 A, | A ₅ [| 3 | 22 🛮 🗛 |
| A4 [| 4 | 21 WE | A4 [| 4 | 21 WE |
| A ₃ [| 5 | 20 OE | A ₃ [| 5 | 20 DĒ |
| A2 [| 6 | 19 A ₁₀ | A ₂ [| 6 | 19 A10 |
| A1 [| 7 | 18 🕽 😇 | A1 [| 7 | 18 CE |
| A ₀ [| 8 | 17 🕽 1/07 | A ₀ [| 8 | 17 107 |
| 1/O ₀ [| 9 | 16 1 1/06 | 1/0, [| 9 | 16 106 |
| 1/0, [| 10 | 15 105 | 1/0, [| 10 | 15 105 |
| 1/02 | 11 | 14 1/04 | I/O₂ [| 11 | 14 1/04 |
| V _{ss} [| 12 | 13 1/03 | v _{ss} [| 12 | 13 1/03 |



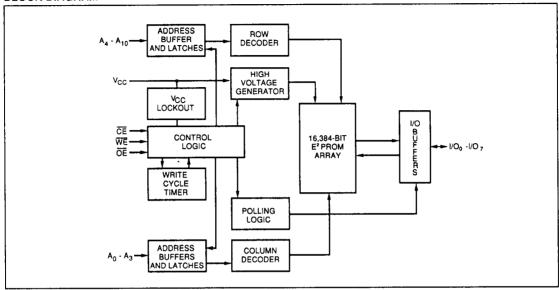


PIN NAMES

| | |
|-----------|-------------------------|
| A0-A10 | Address Inputs |
| 1/00-1/07 | Data Inputs/Outputs |
| CE | Chip Enable |
| ŌĒ | Output Enable |
| WE | Write Enable |
| Vcc | Supply Voltage |
| Vss | Power and Signal Ground |
| NC | No Connect |
| | |



BLOCK DIAGRAM



The XL2816A features $\overline{\text{OE}}$ write inhibit logic and noise protected $\overline{\text{WE}}$, to inhibit inadvertent writes.

The XL2816A is compatible with industrial standard 2K x 8 E²PROMS — its pinouts and operating modes conform to established standards. This compatibility extends to higher and lower density EXEL E²PROMS as well.

APPLICATIONS

The XL2816A provides secure and reliable data storage thoughout your system's lifetime both during periods of power on and power off. It may be written to through standard microprocessor protocols as if it were a Static RAM, yet it retains its data in the absence of system power for at least 10 years after the data is written. This flexibility has resulted in a wide variety of digital system applications.

The nonvolatile storage in the XL2816A replaces dip switches as a means of storing configuration data. It delivers firmware for booting up systems, and for operating industrial and process controllers, traffic controllers, robotics and telemetry, measuring instruments and appliance controls. It retains phone numbers and messages in facsimile machines. The XL2816A is ideal in applications that are self-adapting such as video games and systems that require automatic re-calibration, as well as those that are subject to power failures.

ENDURANCE and DATA RETENTION

The XL2816A is designed for applications requiring up to 10,000 data changes per E²PROM byte ensuring a guaranteed endurance of 20 million data changes per device. It provides 10 years of secure data retention, with or without power applied after the data is written.

DEVICE OPERATION-STANDARD MODES

Three control pins (\overline{CE} , \overline{OE} and \overline{WE}) select all standard, user operating modes for the XL2816A. Chip erase (typically executed during test procedures) requires a higher supply voltage on one input pin. This conforms with existing E²PROM standards.

Read Mode

Data is read from the XL2816A by bringing both \overline{CE} and \overline{OE} LOW while keeping \overline{WE} HIGH. With the read mode selected, address lines can be changed at any time, in any order to read data at various locations in the E^2 PROM array. Read access time is measured from the time when the final controlling line (\overline{CE} or \overline{OE}) goes LOW, or the time when the address is established.

The device can be read an unlimited number of times, because the stored charge that defines the bit state is not affected by a read cycle. (See Figure 2.)



Write Mode

In the XL2816A the write cycle is initiated by applying a logical "0" to both WE and CE while OE is logical "1." The address inputs are latched into the device on the falling edge of WE or CE (whichever is last) to specify the address that is to be written. Data on the I/O pins is then latched into the device by bringing either WE or CE HIGH. Both addresses and data are latched in a brief 200ns interval using a 5V supply and TTL write signals. Once the data is latched, the XL2816A will automatically erase the selected byte and write the new data in less than 10ms. The system is therefore freed to proceed with other operations while the XL2816A autonomously executes its internal write cycle. The I/O pins will be in a high impedance state while the write operation is in progress with the exception of I/O7 if a read command is asserted. (See monitoring device status in the next column of this page.) (See Figures 3 and 4.)

Output Disable Mode

If, while in the read mode, \overline{OE} is brought HIGH, the device remains in the read mode, but with the outputs disabled. (I/O pins are in a high impedance state.)

Standby Mode

Whenever \overline{CE} is brought high, the device is set into its standby mode, placing the I/O pins in a high impedance state. Standby power dissipation is less than 40mA with TTL level inputs. While \overline{CE} remains HIGH, all other input pins are disabled, insulating the device from activity on the system busses.

Chip Erase — High Voltage Mode

The chip erase mode allows the user to erase the entire E^2PROM array with a single command. The method requires the application of high voltage (VH) on the \overline{OE} pin, with \overline{CE} at a logical "0." Chip erase is initiated by a standard byte write command while holding the data on the I/O pins HIGH. A byte containing all "1's" is automatically written to all locations in the E^2PROM array. (Refer to Mode Selection chart.)

MONITORING DEVICE STATUS

Because the internal nonvolatile write cycle is completely managed by the XL2816A, a status indicator has been incorporated to provide for the system to monitor the READY/BUSY status of the device. This is accomplished through a system software routine which simply re-reads the XL2816A until it determines a simple logical condition.

PARALLEL **3**P DCTS

WRITE PROTECT MECHANISMS

The XL2816A features several integrated mechanisms to protect it from inadvertent writes that might occur during system power supply transitions or periods of system noise. In addition to the user-controlled protection mechanisms, the following specialized circuit is built in.

OE Write Inhibit

If \overline{OE} is brought LOW before the \overline{CE} and \overline{WE} write command sequence, the internal nonvolatile write cycle will be inhibited.

MODE SELECTION

| CE | ŌĒ | WE | Mode | I/O | Power |
|-----|-----|-----|----------------------------|-------------------------|---------|
| VIH | X | Х | Standby | HIGH Z | Standby |
| VIL | VIL | ViH | Read | Dout | Active |
| VIL | ViH | 7 | Byte Write (WE Controlled) | DiN | Active |
| 7 | ViH | VIL | Byte Write (CE Controlled) | DiN | Active |
| VIL | Vн | VIL | Chip Erase* | Data In=V _{IH} | Active |
| X | VIL | X | Write Inhibit | | |

^{*}Contact EXEL for details.



ABSOLUTE MAXIMUM RATINGS

| Temperature Under Bias | 40°C to +85°C |
|---|----------------|
| Storage Temperature. | 65°C to +150°C |
| Lead Soldering Temperature (less than 10 seconds) | 300°C |
| Supply Voltage | 0 to 6.5V |
| Voltage on Any Pin* | 0.5V to +6.0V |
| ESD Rating | 2000V |
| DC Output Current | 5mA |
| *With respect to ground | |

Note: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and the functional operation of the device at these or any other conditions indicated in the operational sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Although this product includes specific circuitry to protect it from electrostatic discharge, conventional precautions should be taken to protect it from any voltages higher than the rated maxima.

DC CHARACTERISTICS

 $T_A = 0$ °C to +75°C for the XLS2816A or -40°C to +85°C for the XLE2816A, $V_{CC} = 5V \pm 5\%$

| Symbol | Parameter | Test Conditions | Min | Max | Units |
|-----------------|---|---|-----|-----|-------|
| 1 _{cc} | V _{CC} Current — Active (TTL) | CE = OE = V _{IL} I/O's = open Other Inputs = 5.25V | | 110 | mA |
| I _{SB} | V _{CC} Current — Standby (TTL) | CE = V _{IH} OE = V _{IL} I/O's = open Other Inputs = 5.25V | | 40 | mA |
| I _{LI} | Input Leakage Current | V _{IN} = 0 to 5.25V | | 10 | μА |
| lo | Output Leakage Current | V _{OUT} = 0 to 5.25V | | 10 | μA |
| V _{IL} | Input Low Voltage | | | 0.8 | ٧ |
| V _{IH} | Input High Voltage | | 2.0 | | ٧ |
| V _{OL} | Output Low Voltage | I _{OL} = 2.1mA | | 0.4 | V |
| V _{OH} | Output High Voltage | I _{OH} = -400μA | 2.4 | | V |
| V _H | High Voltage for Chip Erase | | 15 | 18 | v |

CAPACITANCE

 $T_A = +25^{\circ}C$, f = 1.0 MHz

| Symbol | Test | Test Conditions | Max | Units |
|------------------|--------------------------|-----------------------|-----|-------|
| C _{1/O} | Input/Output Capacitance | V _{I/O} = 0V | 10 | pF |
| C _{IN} | Input Capacitance | V _{IN} = 0V | 6 | pF |



AC OPERATING CHARACTERISTICS

READ CYCLE (See Figure 2)

 $T_A = 0$ °C to +75°C for the XLS2816A or -40°C to +85°C for the XLE2816A, $V_{CC} = 5V \pm 5\%$

| | Parameter | | XL2816A-250 Limits | | XL2816A-300 Limits | | XL2816A-350 Limits | | XL2816A-450 Limits | |
|-----------------|------------------------------------|-----|-----------------------|-----|-----------------------|-----|-----------------------|-----|-----------------------|-------|
| Symbol | | Min | Max | Min | Max | Min | Max | Min | Max | Units |
| t _{RC} | Read Cycle Time | 250 | | 300 | | 350 | | 450 | | ns |
| taa | Address Access Time | | 250 | | 300 | | 350 | | 450 | ns |
| t _{CE} | Chip Enable Access Time | | 250 | | 300 | | 350 | | 450 | ns |
| toe | Output Enable Access Time | | 100 | | 120 | | 135 | | 150 | ns |
| t _{LZ} | Chip Enable to Output in Low Z | 10 | | 10 | | 10 | | 10 | | ns |
| t _{HZ} | Chip Disable to Output in High Z | 10 | 100 | 10 | 100 | 10 | 100 | 10 | 100 | ns |
| toLZ | Output Enable to Output in Low Z | 10 | | 10 | | 10 | | 10 | | ns |
| toHz | Output Disable to Output in High Z | 10 | 70 | 10 | 80 | 10 | 100 | 10 | 100 | ns |
| t _{OH} | Output Hold from Address Change | 20 | | 20 | | 20 | | 20 | | ns |



WRITE CYCLE (See Figures 3 and 4)

 $T_A = 0$ °C to +75°C for the XLS2816A or -40°C to +85°C for the XLE2816A, $V_{CC} = 5V \pm 5\%$

| Symbol | Parameter | Min | Max | Units |
|------------------|--|-----|-----|-------|
| twc | Nonvolatile Write Cycle Time | | 10 | ms |
| t _{AS} | Address Setup Time | 10 | | ns |
| t _{AH} | Address Hold Time | 70 | | ns |
| tcs | Chip Enable or Write Enable Setup Time | 0 | | ns |
| t _{CH} | Chip Enable or Write Enable Hold Time | 0 | | ns |
| t _{cw} | Chip Enable Pulse Width | 150 | | ns |
| toes | Output Enable Setup Time | 10 | | ns |
| t _{OEH} | Output Enable Hold Time | 10 | | ns |
| t _{wp} | Write Enable Pulse Width | 150 | | ns |
| t _{wph} | Write Recovery Time | 50 | | ns |
| t _{DV} | Data Valid Time | | 1 | μς |
| t _{DS} | Data Setup Time | 50 | | ns |
| t _{DH} | Data Hold Time | 10 | | ns |
| tINIT | Power-up Initialization Period | | 20 | ms |

